#### SCOPE:

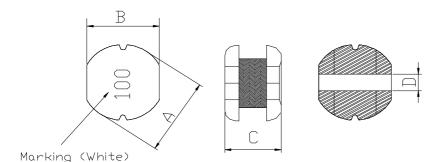
This specification applies to the Pb Free high current type SMD inductors for MSCD-106-SERIES

#### PRODUCT INDENTIFICATION

MSCD - 106 - 100 M

- 1 2 3 4
- ① Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

#### (1) SHAPES AND DIMENSIONS



A: 10.0± 0.3 mm

B: 9.0± 0.3 mm

C: 7.50 Max. mm

D: 3.20 Typ. mm

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

## (3) CHARACTERISTICS

(3)-1 Ambient temperature ......  $+60^{\circ}$  Max.

(3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C

TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC1(A)	IDC2(A)	Marking
MSCD-106-100□	10	М	100kHz/0.25V	60m	3.50	4.20	100
MSCD-106-120□	12	М	100kHz/0.25V	70m	3.40	3.80	120
MSCD-106-150□	15	М	100kHz/0.25V	80m	3.10	3.50	150
MSCD-106-180□	18	М	100kHz/0.25V	90m	3.00	3.20	180
MSCD-106-220□	22	М	100kHz/0.25V	0.10	2.60	2.85	220
MSCD-106-270□	27	М	100kHz/0.25V	0.11	2.40	2.70	270
MSCD-106-330□	33	M	100kHz/0.25V	0.12	2.30	2.50	330
MSCD-106-390□	39	М	100kHz/0.25V	0.14	2.10	2.35	390
MSCD-106-470□	47	M	100kHz/0.25V	0.17	1.95	2.20	470
MSCD-106-560□	56	M	100kHz/0.25V	0.19	1.85	2.00	560
MSCD-106-680□	68	М	100kHz/0.25V	0.22	1.65	1.90	680
MSCD-106-820□	82	M	100kHz/0.25V	0.25	1.50	1.70	820
MSCD-106-101□	100	K,M	100kHz/0.25V	0.35	1.40	1.60	101
MSCD-106-121□	120	K,M	100kHz/0.25V	0.40	1.30	1.40	121
MSCD-106-151□	150	K,M	100kHz/0.25V	0.47	1.20	1.30	151
MSCD-106-181□	180	K,M	100kHz/0.25V	0.63	1.00	1.10	181
MSCD-106-221□	220	K,M	100kHz/0.25V	0.73	0.95	1.05	221
MSCD-106-271□	270	K,M	100kHz/0.25V	0.97	0.90	0.95	271
MSCD-106-331□	330	K,M	100kHz/0.25V	1.15	0.80	0.85	331
MSCD-106-391□	390	K,M	100kHz/0.25V	1.30	0.75	0.80	391
MSCD-106-471□	470	K,M	100kHz/0.25V	1.48	0.65	0.70	471
MSCD-106-561□	560	K,M	100kHz/0.25V	1.90	0.60	0.65	561
MSCD-106-681□	680	K,M	100kHz/0.25V	2.45	0.50	0.55	681
MSCD-106-821□	820	K,M	100kHz/0.25V	2.55	0.48	0.50	821
MSCD-106-102□	1000	K,M	100kHz/0.25V	3.00	0.46	0.48	102

**<sup>※</sup>** ☐ Specify the inductance tolerance, K(±10%),M(±20%)

※ IDC1: Based on inductance change (△L/Lo: drop 10% Max.)@ ambient temperature 25℃

IDC2 : Based on temperature rise ( $\triangle T$ : 40°C TYP.) Rated DC Current : The less value which is IDC1 or IDC2.

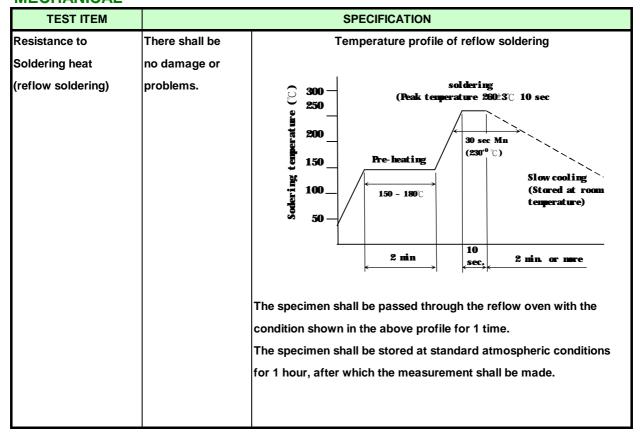


# (4) RELIABILITY TEST METHOD

#### **MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	$\Box$			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150°C and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			

#### **MECHANICAL**



#### **ELECTRICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS			
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top			
resistance	no other	surface and the terminal.			
	damage or	The insulation resistance shall be more than 1 × $10^8$ $\Omega$ .			
	problems.				
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top			
withstand	no other	surface and the terminal of this sample			
voltage	damage or				
	problems.				
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in			
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}{\!$			
		calculated based on the value applicable in a normal			
		temperature and narmal humidity shall be $\triangle$ L/L20 $^{\circ}$ C $\leq$ ±10%.			
l					



#### **ENVIROMENT CHARACTERISTICS**

TEST ITEM				SPECIFICATION		
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with				
storage		a temperature of 85±2 $^{\circ}$ C and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the				
	no mechanical	sample has been left in a normal temperature and normal				
	damage.	humidity for 1 hour.				
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a temperature of -25±3℃.				
	There shall be	Upon completion of the test, the measurement shall be made				
	no mechanical	after the sample has been left in a normal temperature and				
	damage.	normal	humic	lity for 1 hour.		
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the table 2 below and then it shall be subjected to standard				
	There shall be	atmosp	heric	conditions for 1 hour, a	fter which measureme	ent
	no other dama-	shall be made.				
	ge of problems					
				table 2		
				Temperature	Duration	
			1	<b>−25±3</b> ℃	30 min.	
				(Themostat No.1)		
			2	Standard	No.1→No.2	
				atmospheric		
			3	<b>85±2</b> ℃	30 min.	
				(Themostat No.2)		
			4	Standard	No.2→No.1	
				atmospheric	110.2 110.1	
Moisuture storage	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in a temperature of	
		The sample shall be left for 96±4 hours in a temperature of 40±2°C and a humidity(RH) of 90~95%.				
	There shall be	Upon completion of the test, the measurement shall be made				
	no mechanical after the sample has been left in a normal temperature ardamage.					
Test conditions :	-					

The sample shall be reflow soldered onto the printed circuit board in every test.



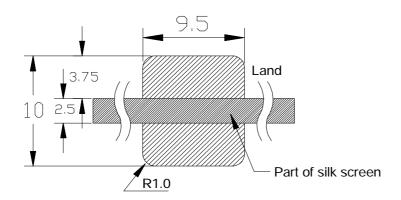
# (5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

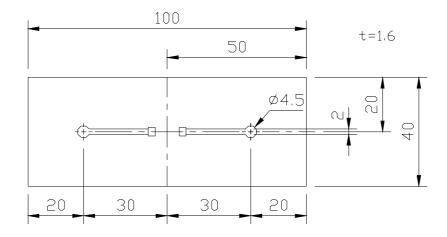
#### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)

Unit:mm

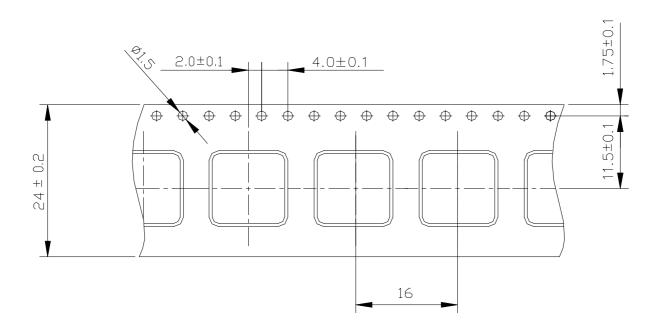


#### (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



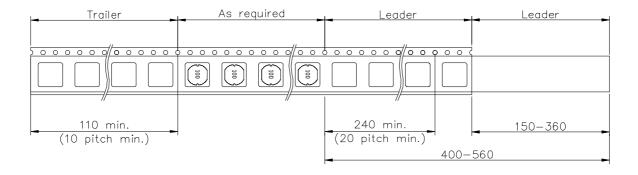
# (6) PACKAGING

### (6)-1 CARRIER TAPE DIMENSIONS (mm)

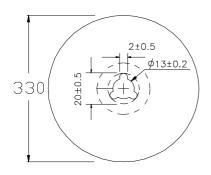


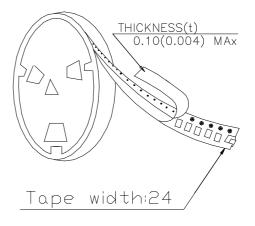
## (6)-2 TAPING DIMENSIONS (mm)





# (6)-3 REEL DIMENSIONS (mm)





## (6)-4 QUANTITY

500 pcs/Reel

The products are packaged so that no damage will be sustained.